

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8957-1	SOT-23-5	-40°C to +125°C	SGM8957-1XN5G/TR	SYBXX	Tape and Reel, 3000
	SC70-5	-40°C to +125°C	SGM8957-1XC5G/TR	SYCXX	Tape and Reel, 3000
	SOIC-8	-40°C to +125°C	SGM8957-1XS8G/TR	SGM 89571XS8 XXXXX	Tape and Reel, 2500
SGM8957-2	SOIC-8	-40°C to +125°C	SGM8957-2XS8G/TR	SGM 89572XS8 XXXXX	Tape and Reel, 2500
	MSOP-8	-40°C to +125°C	SGM8957-2XMS8G/TR	SGM89572 XMS8 XXXXX	Tape and Reel, 4000
	TDFN-3×3-8L	-40°C to +125°C	SGM8957-2XTDB8G/TR	SGM 09DB XXXXX	Tape and Reel, 4000

MARKING INFORMATION

NOTE: XX = Date Code. XXXXX = Date Code and Vendor Code.

SOT-23-5/SC70-5

YYY X X
 └──┬──┬──
 Date Code - Month
 Date Code - Year
 Serial Number

SOIC-8/MSOP-8/TDFN-3×3-8L

XXXXX
 └──┬──┬──┬──┬──
 Vendor Code
 Date Code - Week
 Date Code - Year

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage.....6V
 Input Common Mode Voltage Range
 (-V_S) - 0.3V to (+V_S) + 0.3V
 Junction Temperature.....+150°C
 Storage Temperature Range-65°C to +150°C
 Lead Temperature (Soldering, 10s).....+260°C
 ESD Susceptibility
 HBM.....4000V
 MM.....400V
 CDM1000V

RECOMMENDED OPERATING CONDITIONS

Specified Voltage Range1.8V to 5.5V
 Operating Temperature Range-40°C to +125°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to

absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

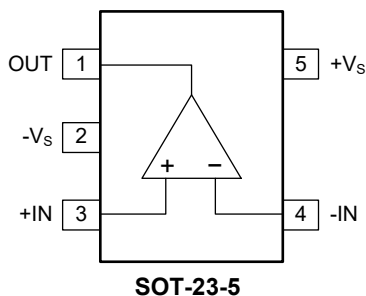
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

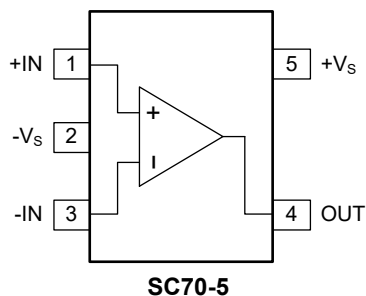
SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS

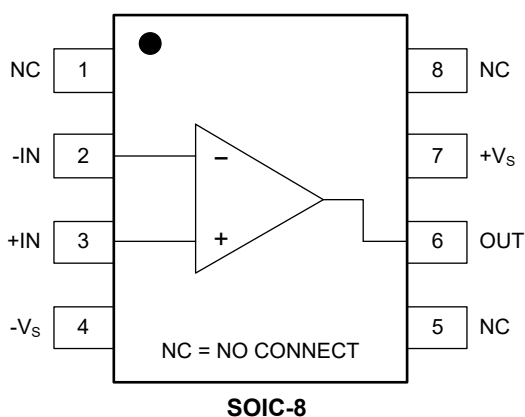
SGM8957-1 (TOP VIEW)



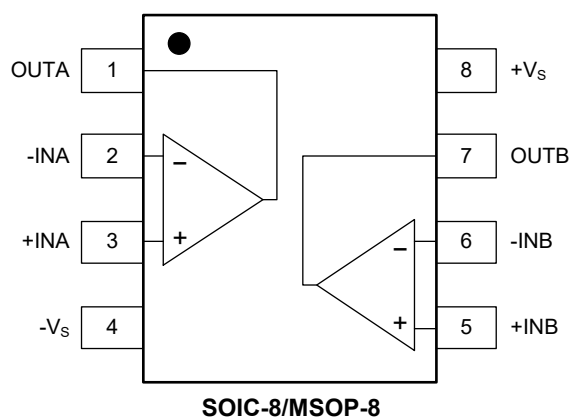
SGM8957-1 (TOP VIEW)



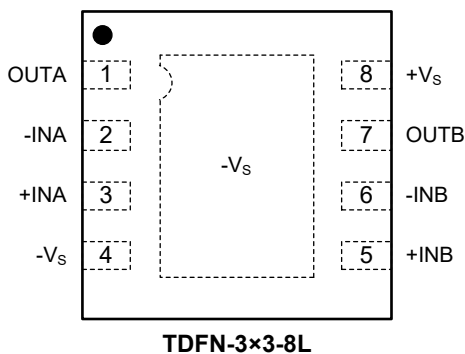
SGM8957-1 (TOP VIEW)



SGM8957-2 (TOP VIEW)



SGM8957-2 (TOP VIEW)



NOTE: For TDFN-3x3-8L package, exposed pad can be connected to $-V_S$ or left floating.

ELECTRICAL CHARACTERISTICS

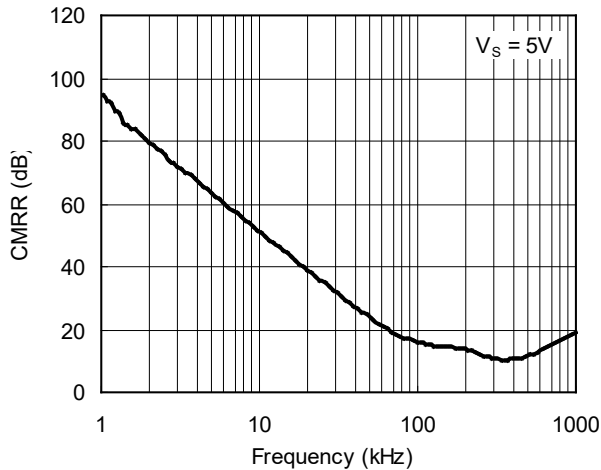
(At $T_A = +25^\circ\text{C}$, $V_S = 1.8\text{V}$ to 5.5V , $V_{CM} = V_S/2$, $V_{OUT} = V_S/2$ and $R_L = 10\text{k}\Omega$ to $V_S/2$, Full = -40°C to $+125^\circ\text{C}$, unless otherwise noted.)

PARAMETER	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
Input Characteristics						
Input Offset Voltage (V _{OS})	V _S = 5V	+25°C		14	25	μV
		Full			55	
Input Offset Voltage Drift (ΔV _{OS} /ΔT)		Full		0.08		μV/°C
Input Bias Current (I _B)		+25°C		130		pA
Input Common Mode Voltage Range (V _{CM})		+25°C	(-V _S) - 0.1		(+V _S) + 0.1	V
Common Mode Rejection Ratio (CMRR)	(-V _S) - 0.1V < V _{CM} < (+V _S) + 0.1V	+25°C	89	100		dB
		Full	85			
Open-Loop Voltage Gain (A _{OL})	(-V _S) + 0.1V < V _{OUT} < (+V _S) - 0.1V, R _L = 10kΩ	+25°C	95	121		dB
		Full	94			
Input Impedance						
Differential		+25°C		10 ⁹		Ω
Common Mode		+25°C		10 ⁹		Ω
Output Characteristics						
Output Voltage Swing from Rail	R _L = 10kΩ	+25°C		14	25	mV
		Full			27	
Output Short-Circuit Current (I _{SC})	V _S = 1.8V	+25°C		6		mA
	V _S = 5V	+25°C		60		
Open-Loop Output Impedance	f = 350kHz, I _{OUT} = 0	+25°C		1		kΩ
Power Supply						
Specified Voltage Range (V _S)		Full	1.8		5.5	V
Power Supply Rejection Ratio (PSRR)	V _S = 1.8V to 5.5V	+25°C		4	20	μV/V
		Full			25	
Quiescent Current/Amplifier (I _Q)	I _{OUT} = 0	+25°C		20	37	μA
		Full			48	
Turn-On Time	V _S = 5V	+25°C		220		μs
Dynamic Performance						
Gain-Bandwidth Product (GBP)	C _L = 100pF	+25°C		350		kHz
Slew Rate (SR)	G = +1	+25°C		0.18		V/μs
Noise						
Input Voltage Noise	f = 0.1Hz to 10Hz	+25°C		2		μV _{P-P}

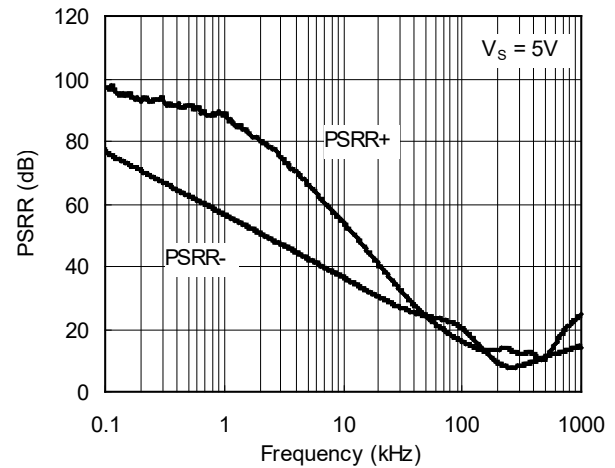
TYPICAL PERFORMANCE CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$ and $C_L = 0\text{pF}$, unless otherwise noted.

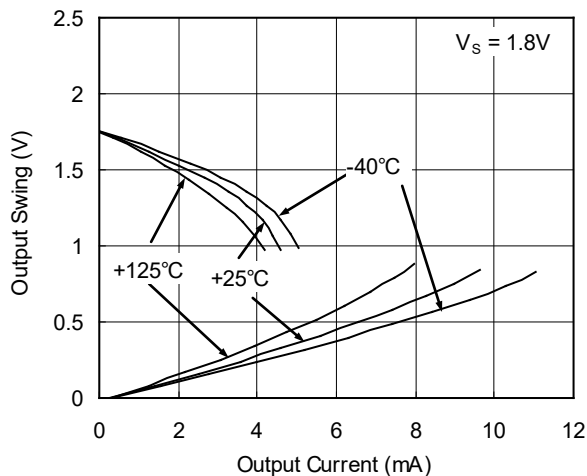
Common Mode Rejection Ratio vs. Frequency



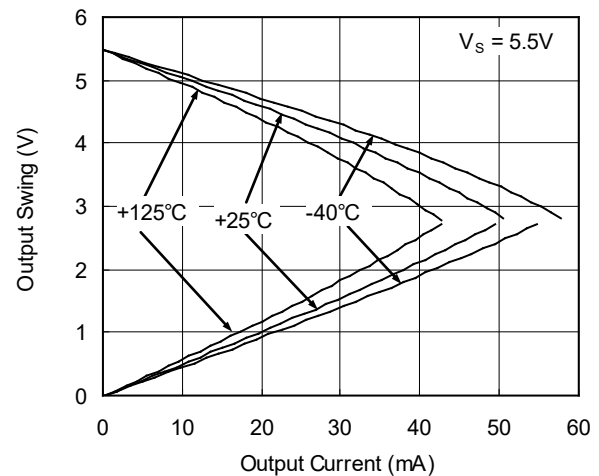
Power Supply Rejection Ratio vs. Frequency



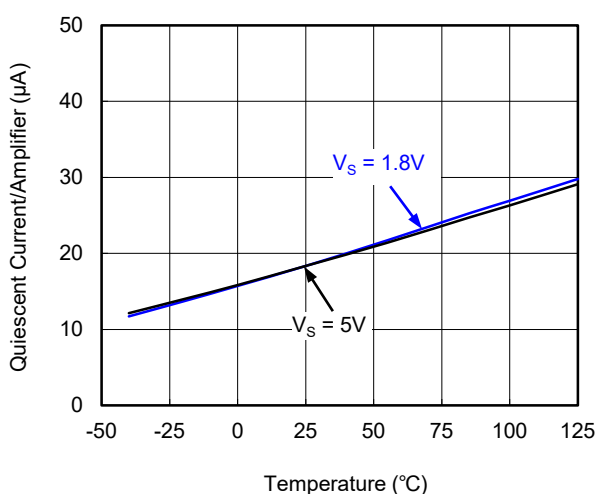
Output Voltage Swing vs. Output Current



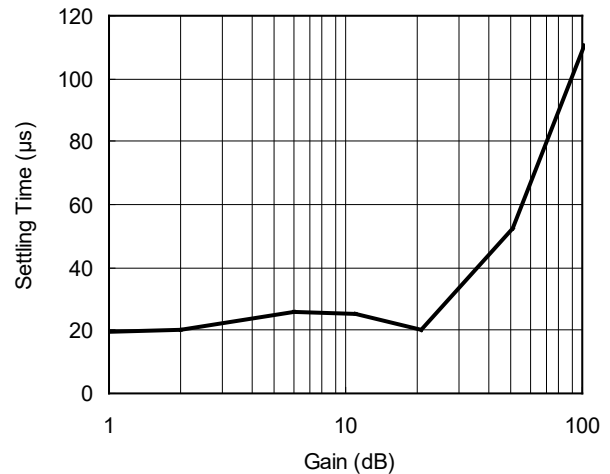
Output Voltage Swing vs. Output Current



Quiescent Current vs. Temperature



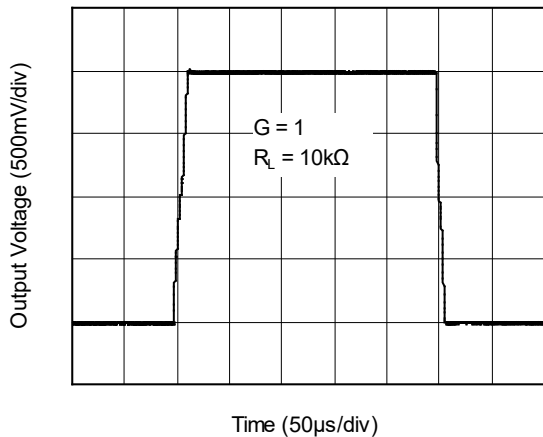
Settling Time vs. Closed-Loop Gain



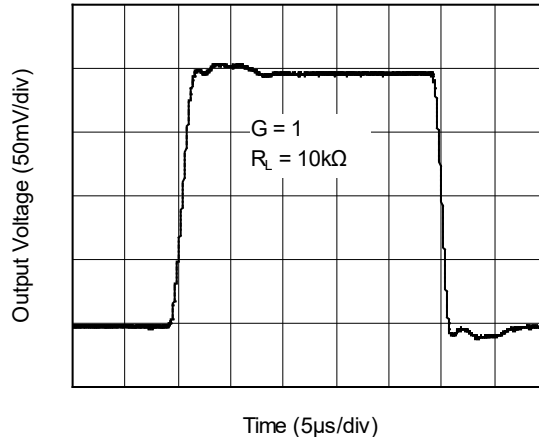
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$ and $C_L = 0\text{pF}$, unless otherwise noted.

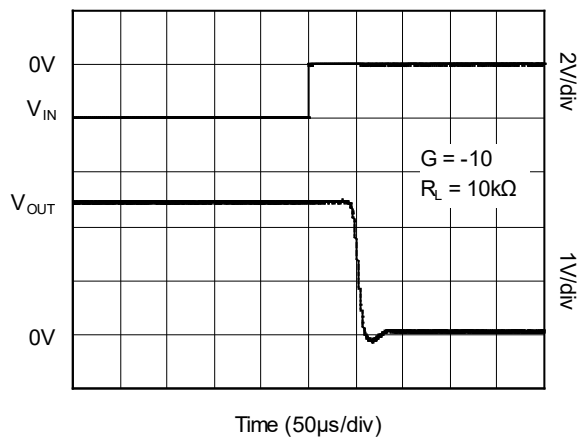
Large-Signal Step Response



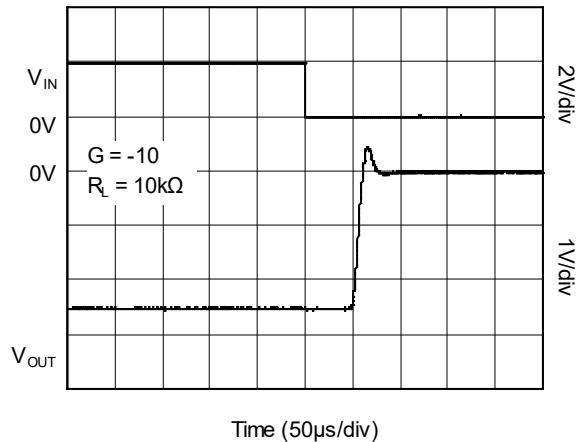
Small-Signal Step Response



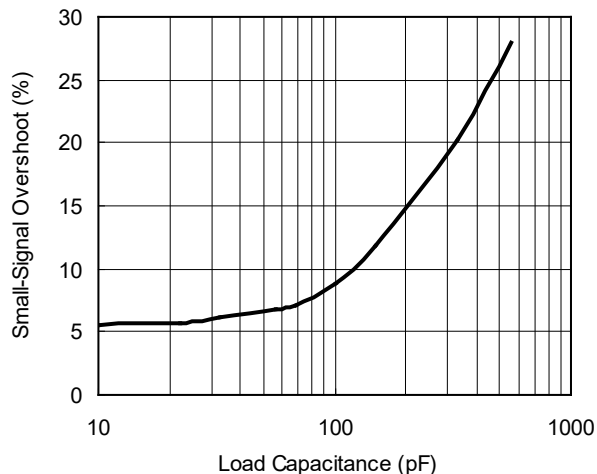
Positive Over-Voltage Recovery



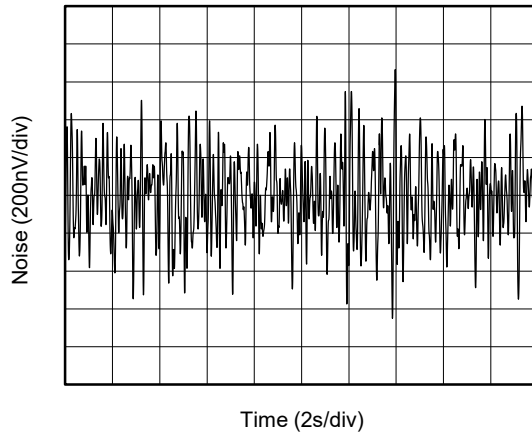
Negative Over-Voltage Recovery



Small-Signal Overshoot vs. Load Capacitance

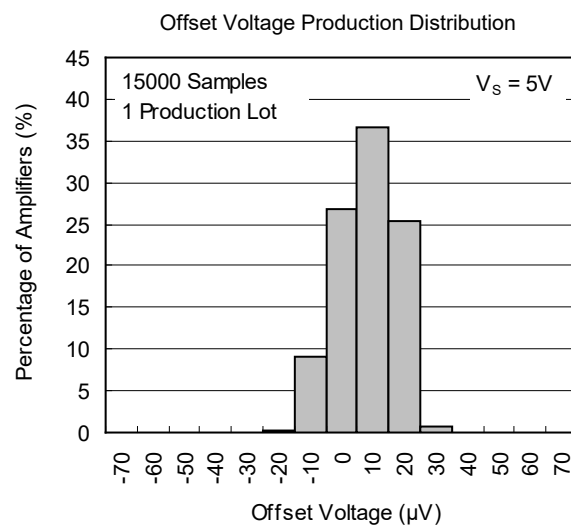
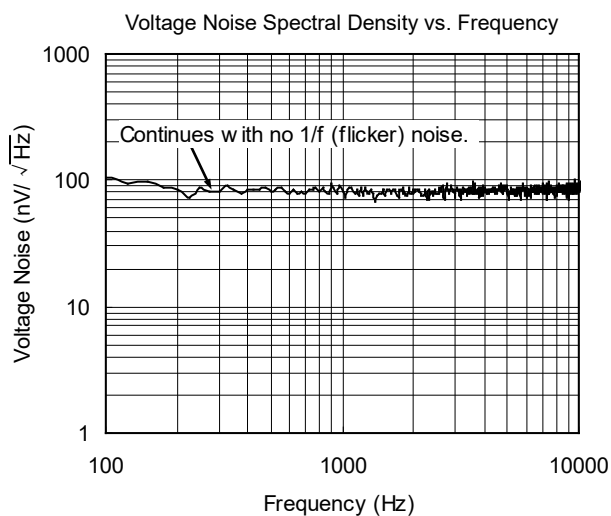


0.1Hz to 10Hz Noise



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$ and $C_L = 0\text{pF}$, unless otherwise noted.



APPLICATION INFORMATION

The SGM8957-1 and SGM8957-2 are unity-gain stable and free from unexpected output phase reversal. They provide low offset voltage and very low drift over time and temperature. For lowest offset voltage and precision performance, circuit layout and mechanical conditions should be optimized. Avoid temperature gradients that create thermoelectric (Seebeck) effects in the thermocouple junctions formed from connecting dissimilar conductors. These thermally-generated potentials can be made to cancel by ensuring they are equal on both input terminals. Other layout and design considerations include:

- Use low thermoelectric-coefficient conditions (avoid dissimilar metals).
- Thermally isolate components from power supplies or other heat sources.
- Shield operational amplifier and input circuitry from air currents, such as cooling fans.

Following these guidelines will reduce the likelihood of junctions at different temperatures.

Operating Voltage

The SGM8957-1/2 operational amplifiers operate over a power supply range of 1.8V to 5.5V ($\pm 0.9V$ to $\pm 2.75V$). Supply voltages higher than 6V (absolute maximum) can permanently damage the device.

Input Voltage

The SGM8957-1/2 input common mode voltage range extends 0.1V beyond the supply rails. The SGM8957-1/2 are designed to cover the full range without the troublesome transition region found in some other rail-to-rail amplifiers.

Normally, input bias current is about 130pA; however, input voltages exceeding the power supplies can cause excessive current flowing into or out of the input pins.

Internal Offset Correction

The SGM8957-1/2 operational amplifiers use an auto-calibration technique to reduce internal offset. Upon power-up, the amplifier requires approximately 220 μ s to achieve specified V_{OS} accuracy.

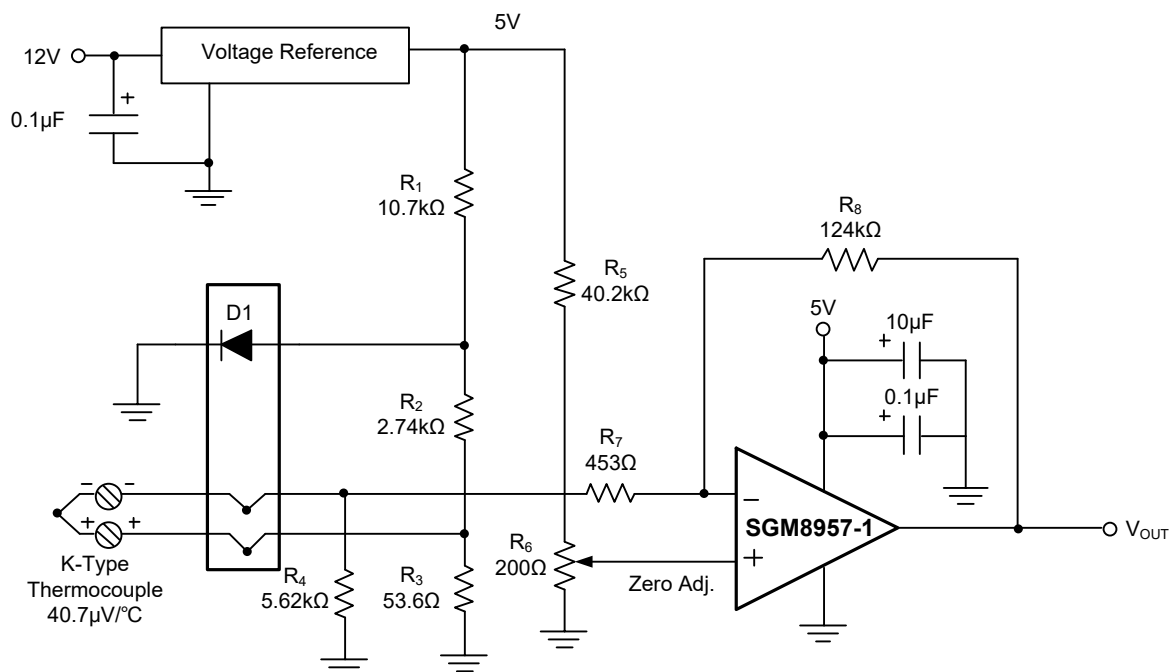


Figure 1. Temperature Measurement

APPLICATION INFORMATION (continued)

General Layout Guidelines

Attention to good layout practices is always recommended. Keep traces short and, when possible, use a printed circuit board (PCB) ground plane with surface-mount components placed as close to the device pins as possible. Place a $0.1\mu\text{F}$ capacitor closely across the supply pins. These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI (electromagnetic interference) susceptibility. Operational amplifiers vary in their susceptibility to radio frequency interference (RFI). RFI can generally be identified as a variation in offset voltage or DC signal levels with changes in the interfering RF signal. The SGM8957-1/2 have been specifically designed to minimize susceptibility to RFI and demonstrate remarkably low sensitivity. Strong RF fields may still cause varying offset levels.

Figure 2 shows the basic configuration for a bridge amplifier.

A low-side current shunt monitor is shown in Figure 3. R_N are operational resistors used to isolate the ADC from the noise of the digital I²C bus. Since the ADC is a 16-bit converter, a precision reference is essential for maximum accuracy. Related application circuits are shown in Figure 4 ~ 6.

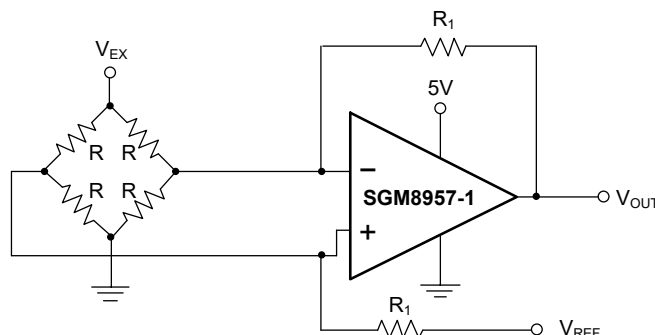


Figure 2. Bridge Amplifier Configuration

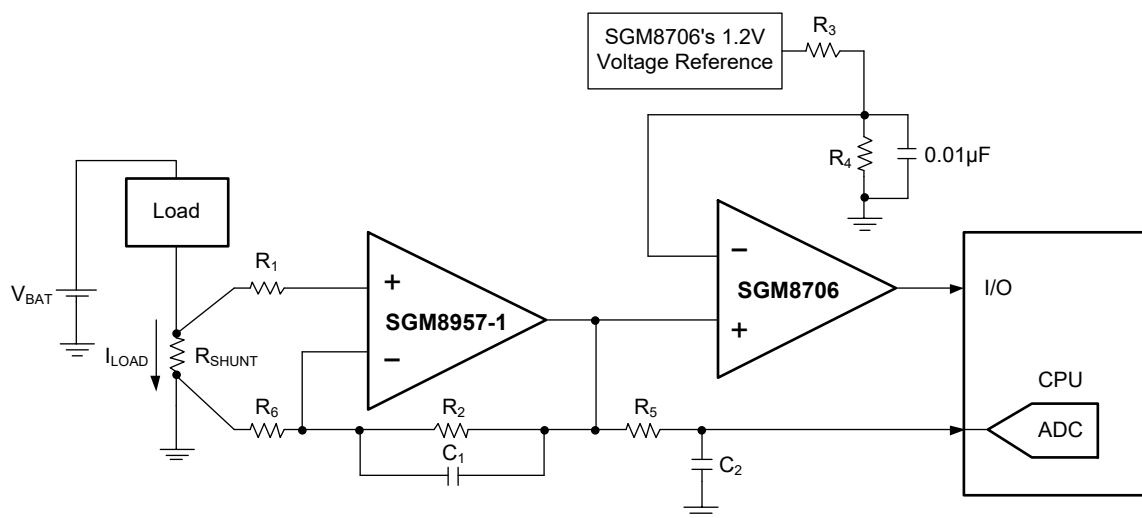
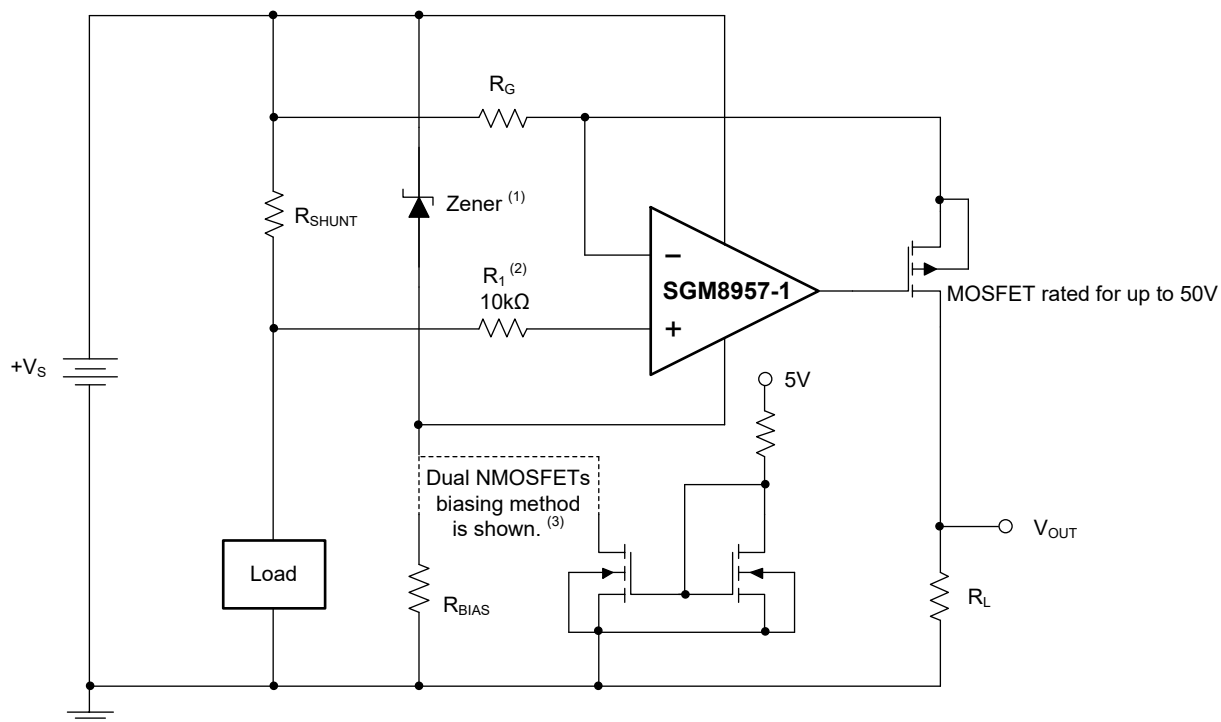


Figure 3. Low-side Current Shunt Monitor

APPLICATION INFORMATION (continued)



- NOTES: 1. Zener rated for operational amplifier supply capability (that is, 5.1V for SGM8957-1 and SGM8957-2).
 2. Current-limit resistor.
 3. Choose Zener biasing resistor or dual NMOSFETs.

Figure 4. High-side Current Shunt Monitor

APPLICATION INFORMATION (continued)

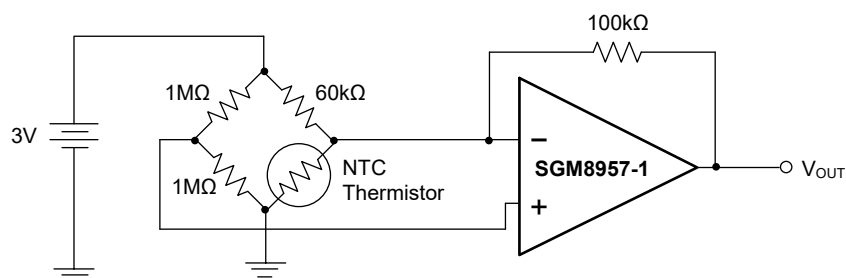


Figure 5. Thermistor Measurement

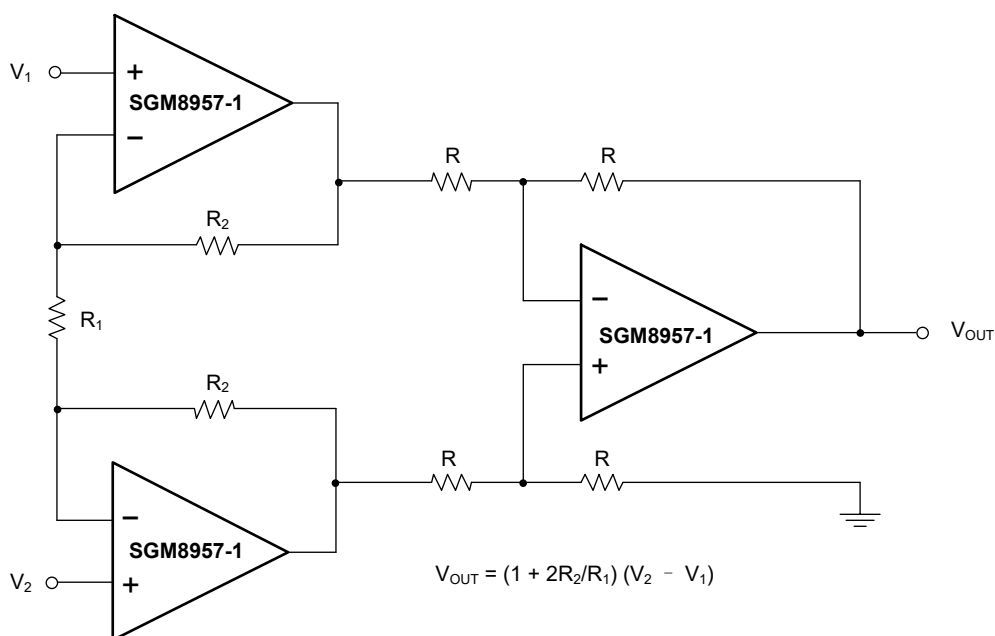


Figure 6. Precision Instrumentation Amplifier Configuration

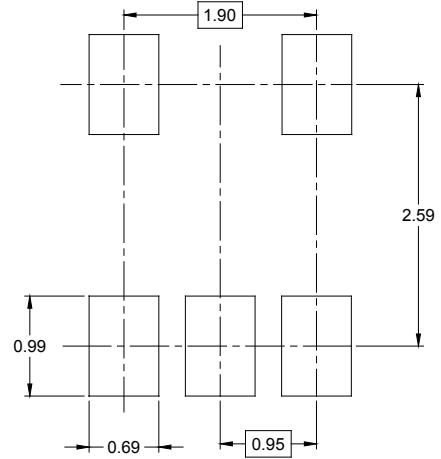
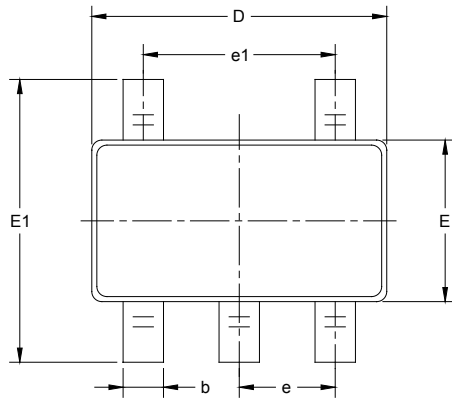
REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

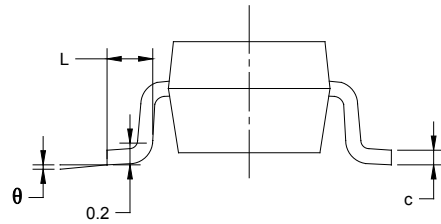
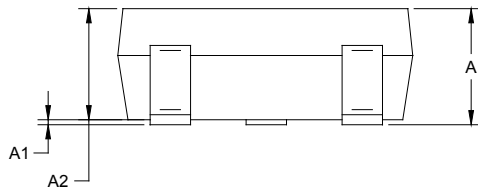
OCTOBER 2020 – REV.A.2 to REV.A.3	Page
Updated Typical Performance Characteristics section	6
Deleted Achieving Output Swing to the Operational Amplifier Negative Rail section	8
OCTOBER 2016 – REV.A.1 to REV.A.2	Page
Changed Typical Performance Characteristics section	5
APRIL 2016 – REV.A to REV.A.1	Page
Added SOIC-8 and MSOP-8 packages	All
Changes from Original (SEPTEMBER 2015) to REV.A	Page
Changed from product preview to production data	All

PACKAGE OUTLINE DIMENSIONS

SOT-23-5



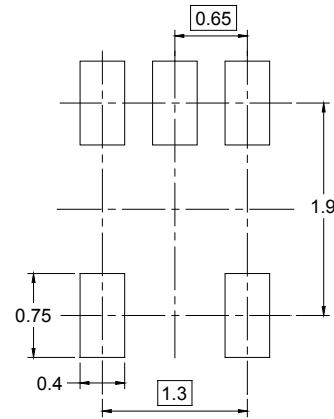
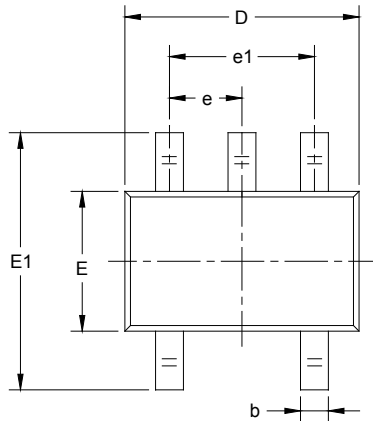
RECOMMENDED LAND PATTERN (Unit: mm)



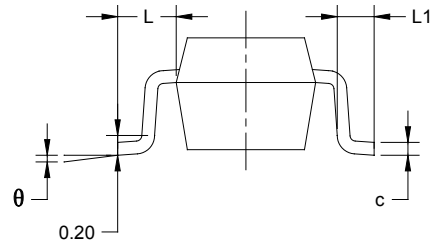
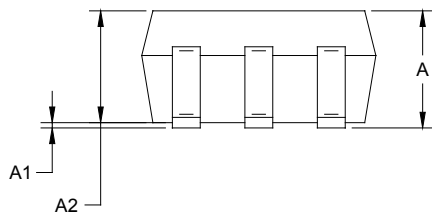
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

SC70-5



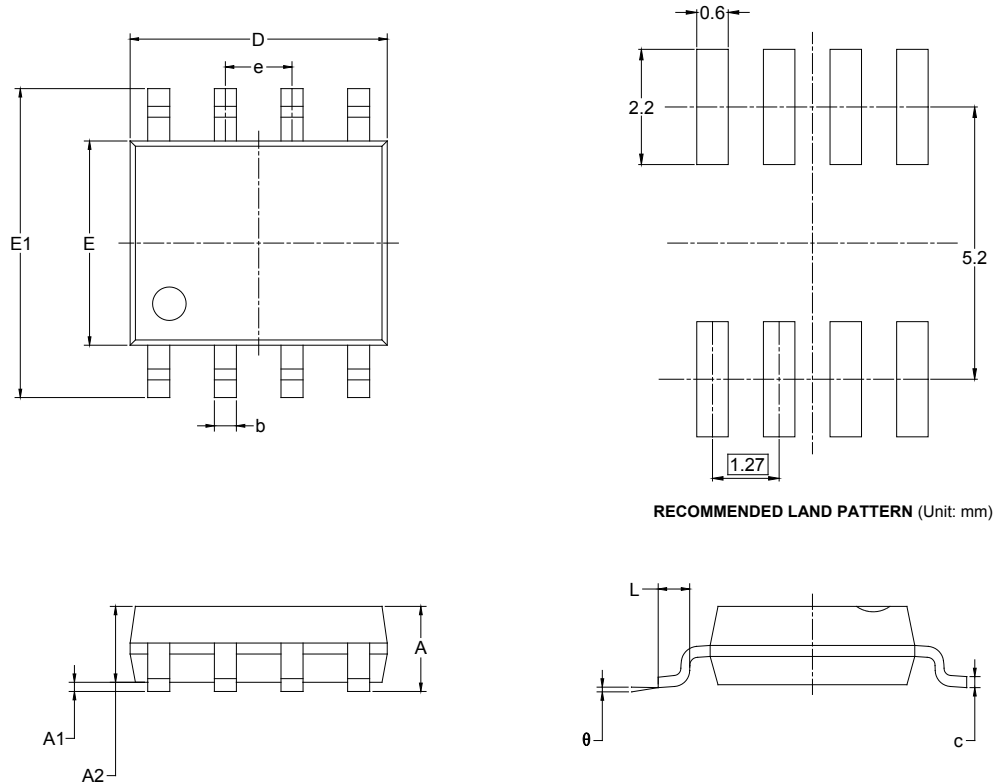
RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.65 TYP		0.026 TYP	
e1	1.300 BSC		0.051 BSC	
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

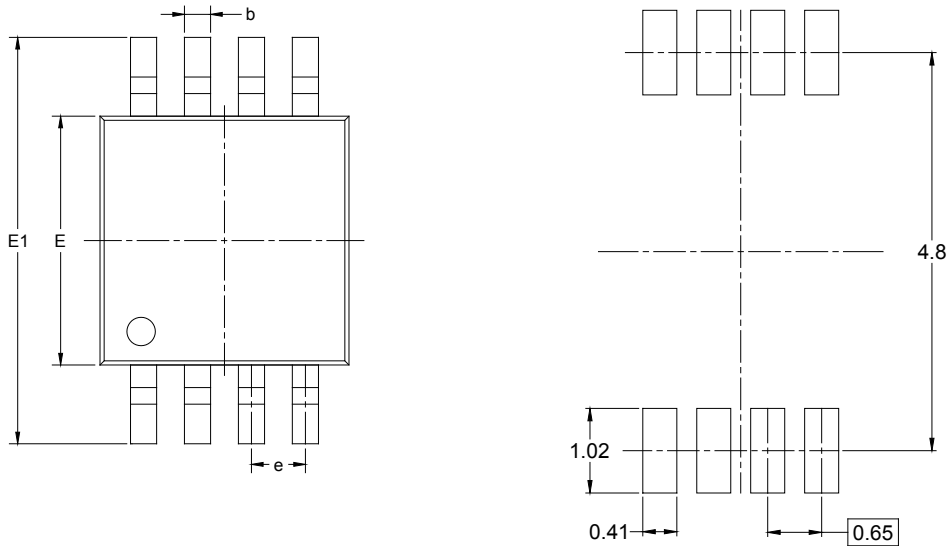
SOIC-8



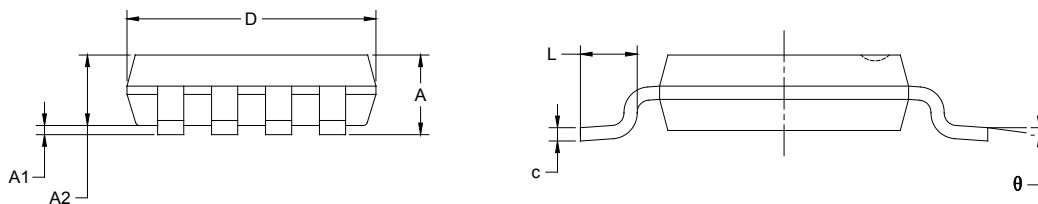
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

MSOP-8



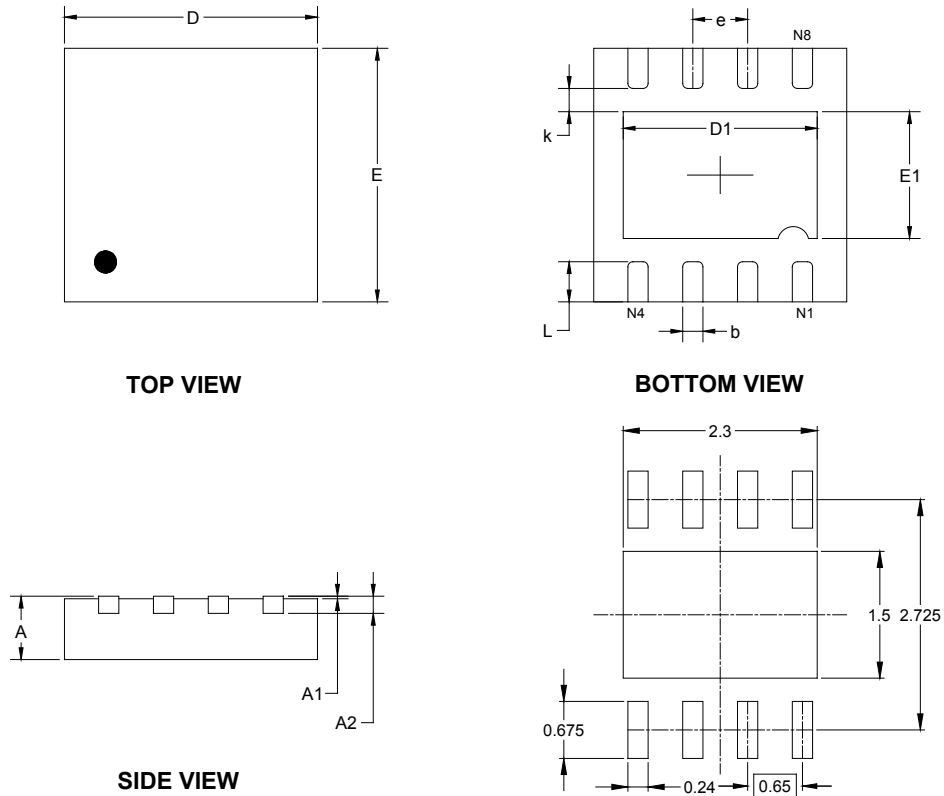
RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
e	0.650 BSC		0.026 BSC	
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

PACKAGE OUTLINE DIMENSIONS

TDFN-3×3-8L



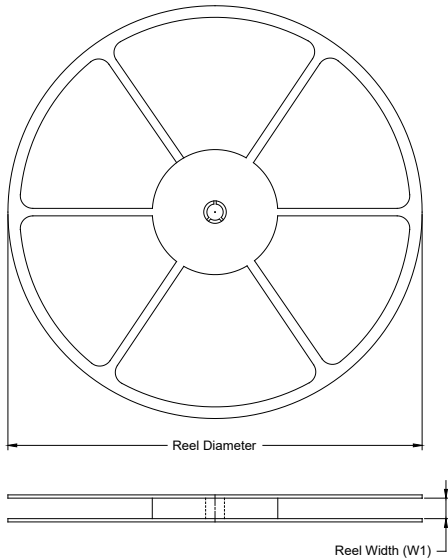
RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203 REF		0.008 REF	
D	2.900	3.100	0.114	0.122
D1	2.200	2.400	0.087	0.094
E	2.900	3.100	0.114	0.122
E1	1.400	1.600	0.055	0.063
k	0.200 MIN		0.008 MIN	
b	0.180	0.300	0.007	0.012
e	0.650 TYP		0.026 TYP	
L	0.375	0.575	0.015	0.023

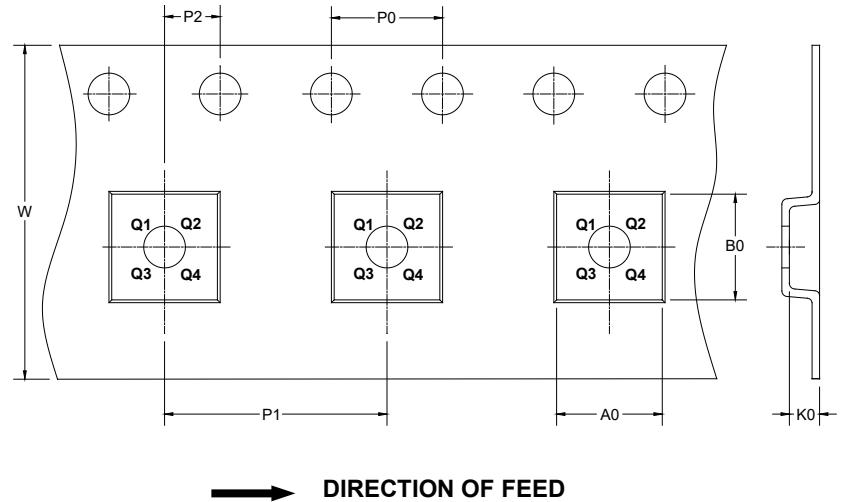
PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

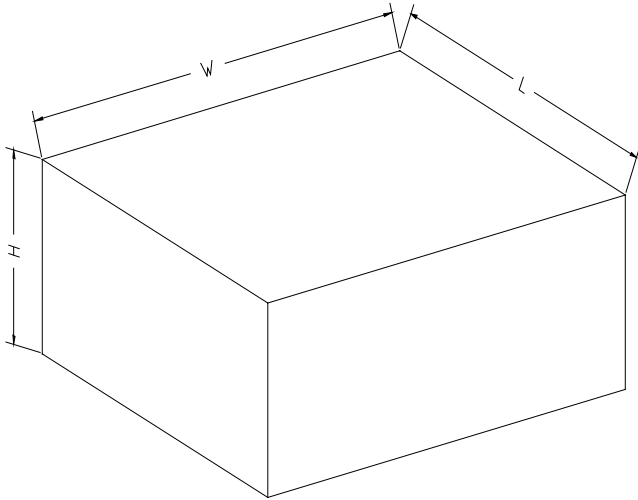
KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3
SC70-5	7"	9.5	2.25	2.55	1.20	4.0	4.0	2.0	8.0	Q3
SOIC-8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1
MSOP-8	13"	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1
TDFN-3×3-8L	13"	12.4	3.35	3.35	1.13	4.0	8.0	2.0	12.0	Q1

DD0001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18
13"	386	280	370	5

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